



Mini-Circuits®

SURFACE MOUNT

Directional Coupler

TCD-9-1W+

50Ω

5 to 2000 MHz

FEATURES

- Wideband, 5 to 2000 MHz
- Low mainline loss, 1.2 dB typ. (5-1000 MHz)
- Aqueous washable
- Leads for excellent solderability
- Protected by US Patent 6,140,887

APPLICATIONS

- GPS
- Cellular
- Satellite distribution
- CABLE TV



Generic photo used for illustration purposes only

CASE STYLE: DB714

+RoHS Compliant

The +Suffix identifies RoHS Compliance.
See our website for methodologies and qualifications

ELECTRICAL SPECIFICATIONS AT 25°C

Parameter	Frequency (MHz)	Min.	Typ.	Max.	Unit
Frequency Range	—	5	—	2000	MHz
Mainline Loss ¹ (above theoretical 0.1 dB)	5-50	—	1.2	2.1	dB
	50-500	—	1.2	1.8	
	500-1000	—	1.5	2.1	
	1000-2000	—	2.5	—	
Coupling	5-1000	—	8.9±0.5	—	dB
	1000-2000	—	8.9±0.5	—	
Coupling Flatness (±)	5-2000	—	±0.6	—	
Directivity	5-50	17	21	—	dB
	50-500	13	17	—	
	500-1000	10	13	—	
	1000-2000	—	10	—	
VSWR	5-1000	—	1.30	—	:1
	1000-2000	—	1.60	—	
Input Power	5-1000	—	—	0.5	W
	1000-2000	—	—	1.0	

1. Mainline loss includes theoretical power loss at coupled port.

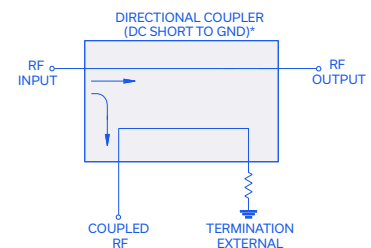
MAXIMUM RATINGS

Parameter	Ratings
Operating Temperature	-40°C to 85°C*
Storage Temperature	-55°C to 100°C

Permanent damage may occur if any of these limits are exceeded.

* Case temperature is defined as temperature on ground leads.

ELECTRICAL SCHEMATIC



*Electrical schematic is for Directional coupler with internal transformer(s) and external termination

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220809
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Directional Coupler

50Ω

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INPUT	3
OUTPUT	4
COUPLED	1
GROUND	2
50Ω TERM EXTERNAL	6
NOT USED	5

Lead #1 identifier shall be located in the cross-hatched area shown. Identifier may be either a molded or marked feature.

The diagram illustrates the layout of a component with six leads. The top view shows a rectangular component with leads 1 through 6. Lead 1 is located in a cross-hatched area. Dimensions include B (width), A (height), and C MAX (distance from lead 1 to the opposite edge). The side view shows the component's profile with dimensions D TYP (height), E (+.005 / -.009 TYP) (thickness), and F TYP (distance from lead 1 to the bottom edge). The component area is labeled 'COMPONENT AREA' and the pick & place surface area is labeled 'PICK & PLACE SURFACE AREA (.03X.075)MIN.'.

COMPONENT AREA

PICK & PLACE SURFACE AREA (.03X.075)MIN.

D TYP

E $\begin{smallmatrix} +.005 \\ -.009 \end{smallmatrix}$ TYP

F TYP

C MAX

A

B

1 2 3 4 5 6

PLASTIC SHAPE ADJACENT TO LEADS MAY VARY

 DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

The diagram shows a three-layered structure. The top layer has a thickness labeled 'D TYP'. The middle layer has a thickness labeled 'K TYP'. The bottom layer has a thickness labeled 'H TYP'. The total height of the structure is labeled 'J'. The layers are represented by hatched rectangles.

OUTLINE DIMENSIONS (Inches)

A	B	C	D	E	F
.160	.150	.160	.050	.040	.025
4.06	3.81	4.06	1.27	1.02	0.64
G	H	J	K		wt
.028	.065	.190	.030		grams
0.71	1.65	4.83	0.76		0.15



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SURFACE MOUNT

Directional Coupler

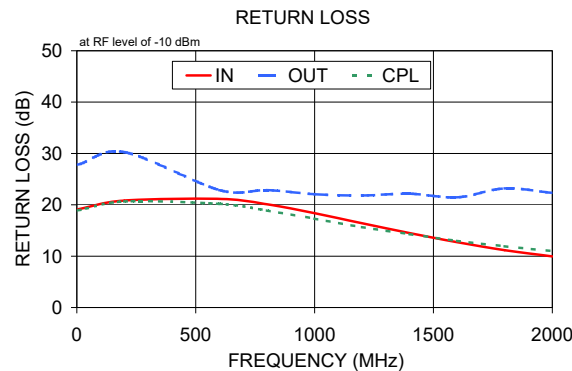
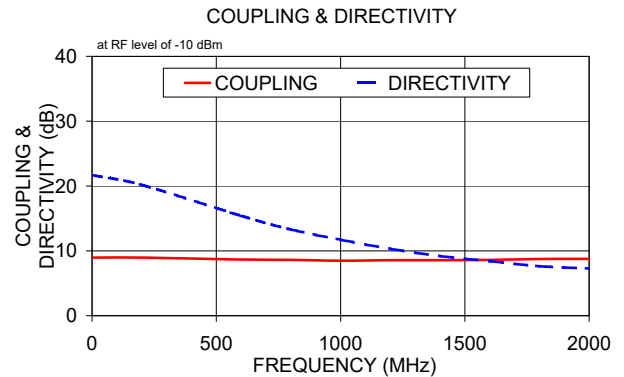
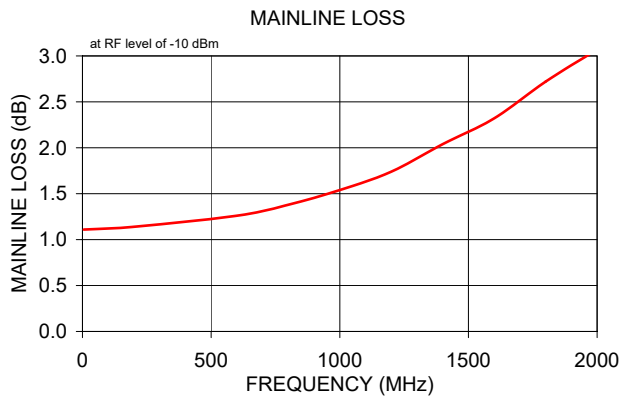
TCD-9-1W+

50Ω

5 to 2000 MHz

TYPICAL PERFORMANCE DATA

Frequency (MHz)	Mainline Loss (dB)	Coupling (dB)	Directivity (dB)	Return Loss (dB)		
	In-Out	In-Cpl		In	Out	Cpl
5.00	1.11	8.96	21.65	19.14	27.81	18.92
200.00	1.14	8.97	20.18	20.84	30.26	20.66
600.00	1.26	8.67	15.41	21.16	22.87	20.18
800.00	1.38	8.61	13.30	20.11	22.87	18.90
1000.00	1.54	8.48	11.72	18.37	22.07	17.30
1200.00	1.74	8.57	10.31	16.42	21.82	15.67
1400.00	2.04	8.57	9.19	14.49	22.16	14.29
1600.00	2.32	8.61	8.42	12.72	21.46	12.97
1800.00	2.72	8.75	7.63	11.17	23.19	11.93
2000.00	3.07	8.76	7.28	9.96	22.33	10.99



NOTES

- A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
- B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.
- C. The parts covered by this specification document are subject to Mini-Circuits standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the standard. Terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at www.minicircuits.com/terms/viewterm.html



Directional Coupler

TCD-9-1W+

Typical Performance Data

FREQUENCY (MHz)	INSERTION LOSS (dB)	COUPLING (dB)	DIRECTIVITY (dB)	RETURN LOSS		
				IN	(dB) OUT	CPL
5.0	1.11	8.96	21.65	19.14	27.81	18.92
200.0	1.14	8.97	20.18	20.84	30.26	20.66
600.0	1.26	8.67	15.41	21.16	22.87	20.18
800.0	1.38	8.61	13.30	20.11	22.87	18.90
1000.0	1.54	8.48	11.72	18.37	22.07	17.30
1200.0	1.74	8.57	10.31	16.42	21.82	15.67
1400.0	2.04	8.57	9.19	14.49	22.16	14.29
1600.0	2.32	8.61	8.42	12.72	21.46	12.97
1800.0	2.72	8.75	7.63	11.17	23.19	11.93
2000.0	3.07	8.76	7.28	9.96	22.33	10.99

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070611
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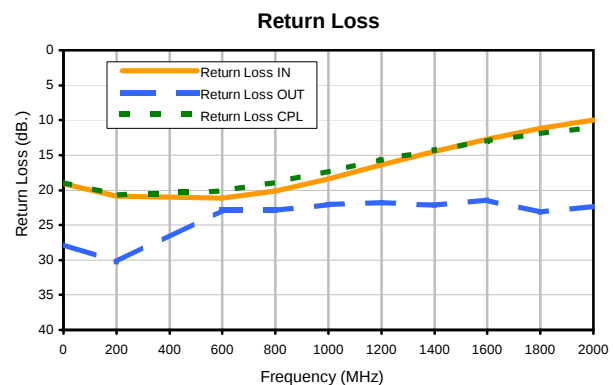
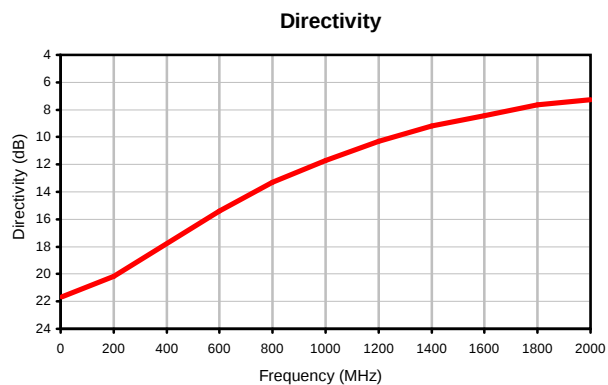
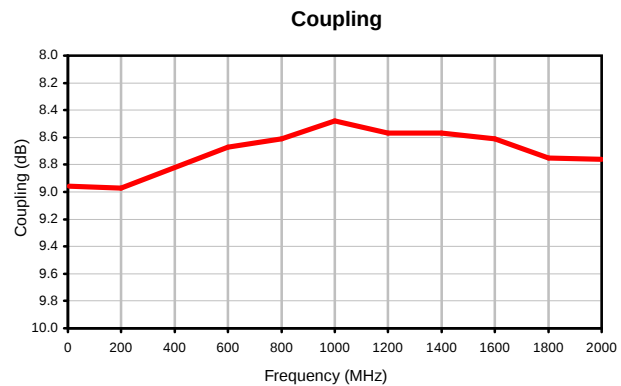
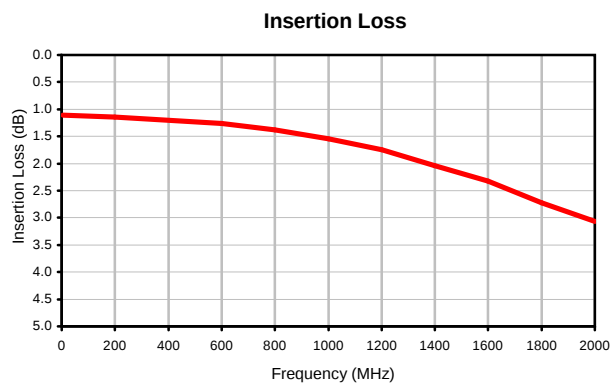
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Directional Coupler

TCD-9-1W+

Typical Performance Curves



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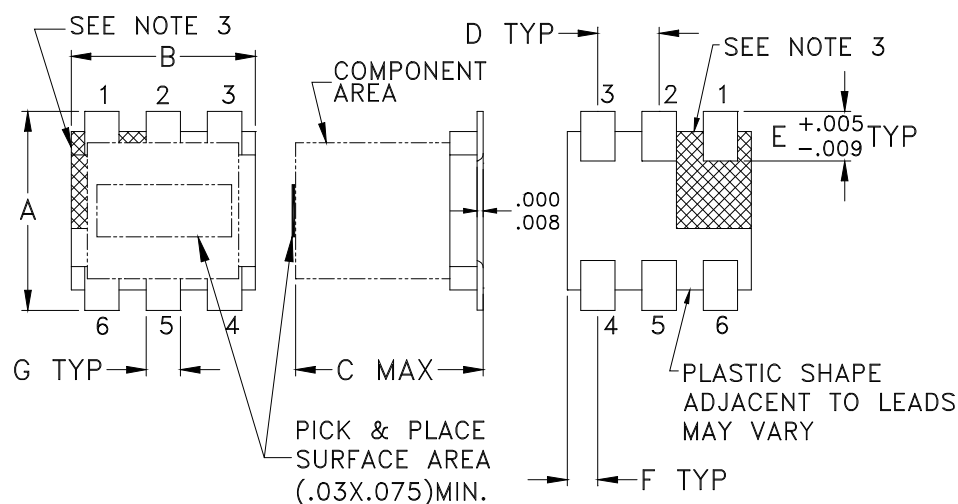


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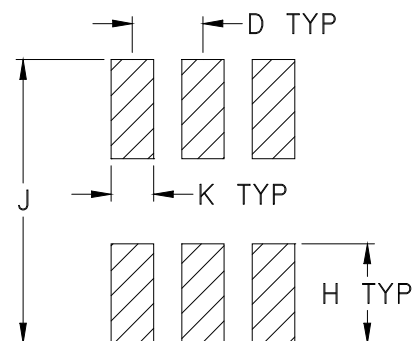


Outline Dimensions

DB714



PCB Land Pattern



Suggested Layout,
Tolerance to be within $\pm .002$

CASE #	A	B	C	D	E	F	G	H	J	K	WT. GRAM
DB714	.160 (4.06)	.150 (3.81)	.160 (4.06)	.050 (1.27)	.040 (1.02)	.025 (0.64)	.028 (0.71)	.065 (1.65)	.190 (4.83)	.030 (0.76)	.15

Dimensions are in inches (mm). Tolerances: 2 Pl. $\pm .01$; 3Pl. $\pm .005$

Notes:

- Case material: Plastic.
- Termination finish:
For RoHS Case Styles: Tin plate over Nickel plate. All models, (+) suffix.
For RoHS-5 Case Styles: Tin-Lead plate. All models, no (+) suffix.
- Lead #1 identifier shall be located in the cross-hatched area shown.
Identifier may be either a molded or marked feature.



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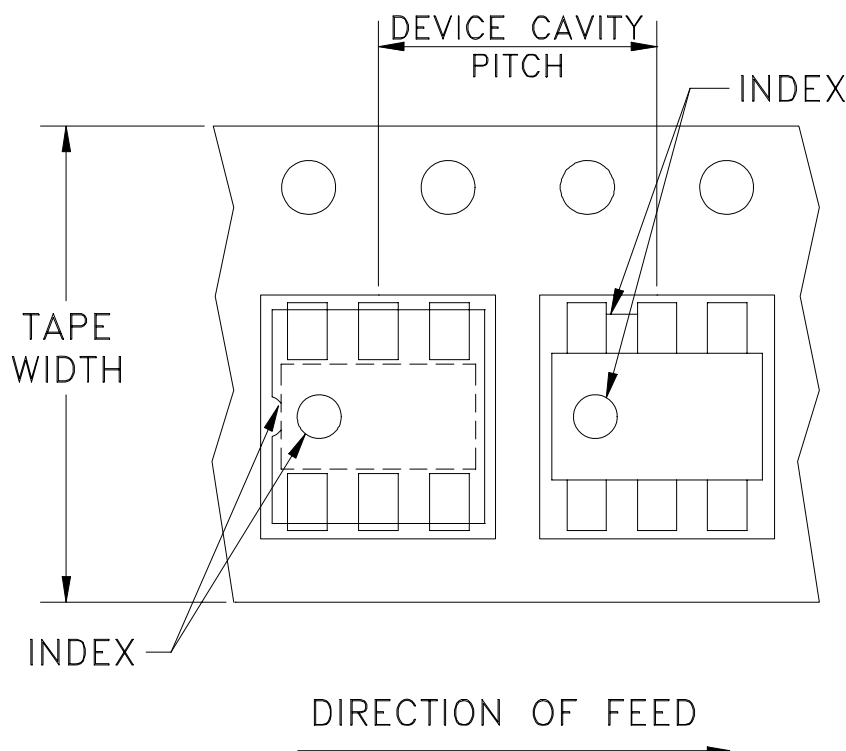


The Design Engineers Search Engine Provides ACTUAL Data Instantly From MINI-CIRCUITS At: www.minicircuits.com

RF/IF MICROWAVE COMPONENTS

Tape & Reel Packaging TR-F47

DEVICE ORIENTATION IN T&R



Tape Width, mm	Device Cavity Pitch, mm	Reel Size, inches	Devices per Reel see note
12	8	13	1000, 2000
		7	20, 50, 100, 200, 500

Note: Please consult individual model data sheet to determine device per reel availability.

Mini-Circuits carrier tape materials provide protection from ESD (Electro-Static Discharge) during handling and transportation. Tapes are static dissipative and comply with industry standards EIA-481/EIA-541.

Go to: www.minicircuits.com/pages/pdfs/tape.pdf



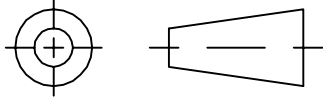
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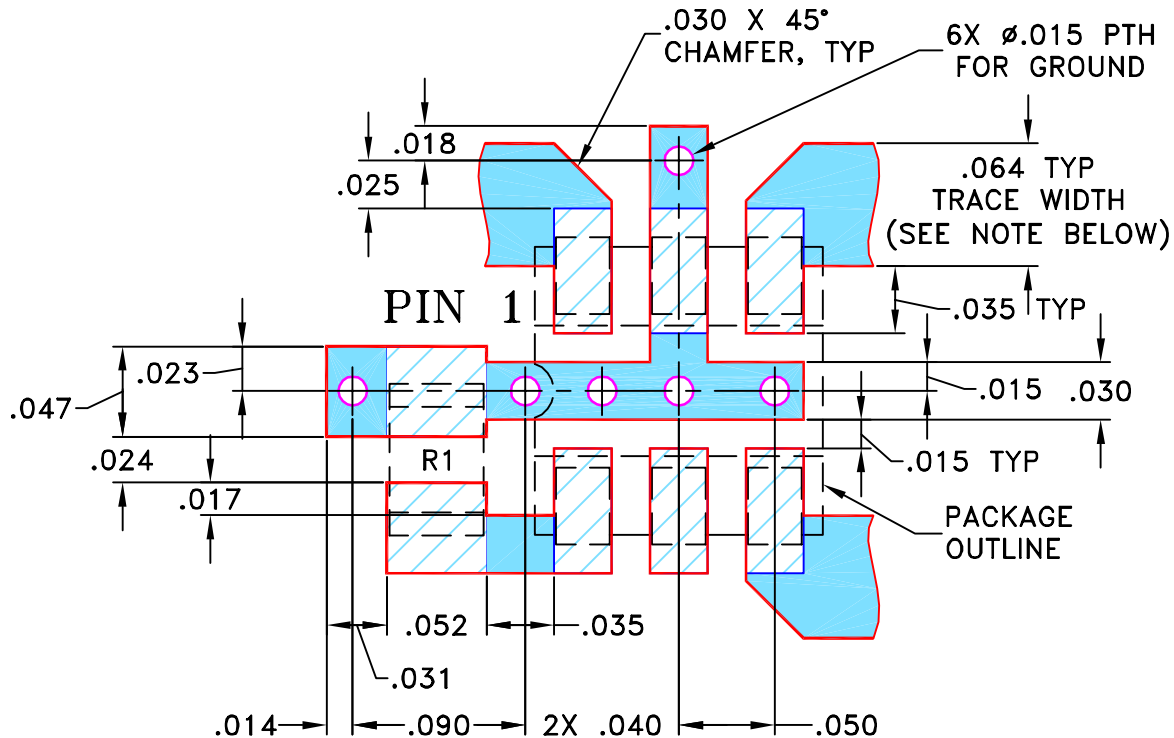
THIRD ANGLE PROJECTION



REVISIONS

REV	ECN No.	DESCRIPTION	DATE	DR	AUTH
OR	M73159	NEW RELEASE	08/00	IL	DB
A	M82377	UPDATED DRAWING	07/21/02	AV	LC
B	M102713	UPDATED NOTES	01/12/08	GF	IL

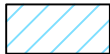
SUGGESTED MOUNTING CONFIGURATION FOR DB714 CASE STYLE, "mm" PIN CONNECTION



RESISTOR R1: $49.9 \pm 1\%$ Ohm, 0805 SIZE

NOTES: 1. TRACE WIDTH IS SHOWN FOR ROGERS RO4350B WITH DIELECTRIC THICKNESS $0.030'' \pm 0.002''$; COPPER: 1/2 OZ. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH MAY NEED TO BE MODIFIED.

2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.

-  DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER)
-  DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

UNLESS OTHERWISE SPECIFIED

INITIALS

DATE

DIMENSIONS ARE IN INCHES

TOLERANCES ON:
2 PL DECIMALS $\pm .005$
3 PL DECIMALS $\pm$
ANGLES $\pm$
FRACTIONS $\pm$

DRAWN

IL

08/03/00

CHECKED

WP

08/08/00

APPROVED

DB

08/08/00

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ASHEETA1.DWG REV:A DATE:01/12/95



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Brooklyn NY 11235

PL, mm, DB714, TCD, TB-71

SIZE
A

CODE IDENT
15542

DRAWING NO:
98-PL-009

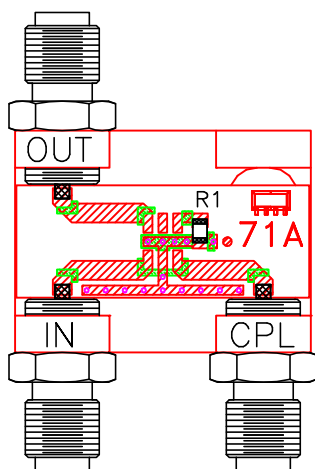
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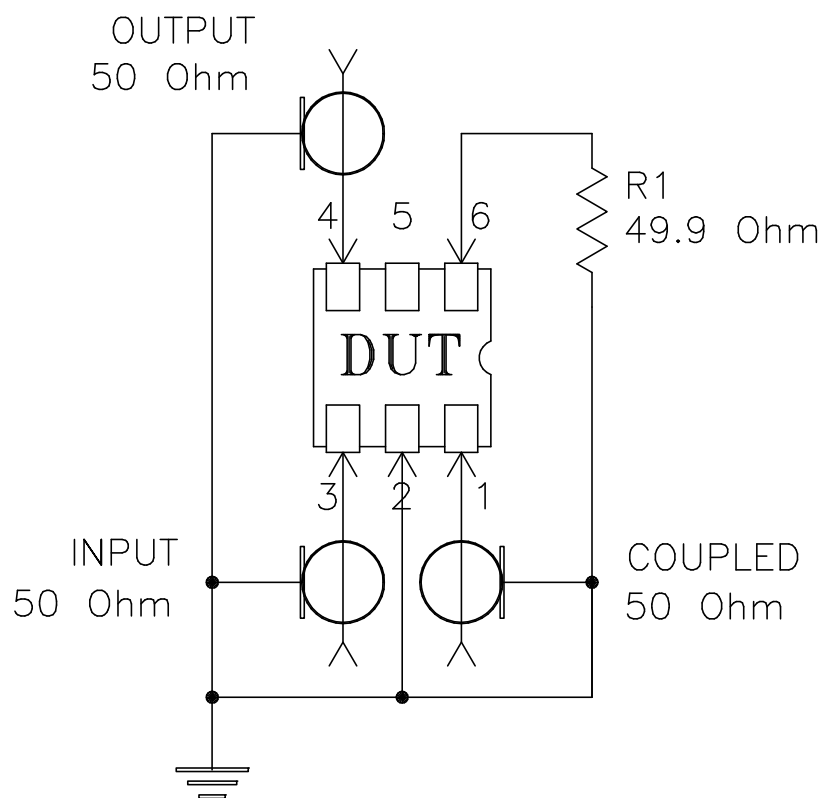
SCALE: 10:1

SHEET: 1 OF 1

Evaluation Board and Circuit



TB-71



Schematic Diagram

Notes:

1. SMA Female connectors.
2. PCB Material: Rogers R04350 or equivalent,
Dielectric Constant=3.5, Thickness=.030 inch.

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All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-40° to 85°C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-55° to 100° C Ambient Environment	Individual Model Data Sheet
Humidity	90 to 95% RH, 240 hours, 50°C	MIL-STD-202, Method 103, Condition A, Except 50°C and end-point electrical test done within 12 hours
Thermal Shock	-55° to 100°C, 100 cycles	MIL-STD-202, Method 107, Condition A-3, except +100°C
Solder Reflow Heat	Sn-Pb Eutetic Process: 225°C peak Pb-Free Process 245° - 250°C peak	J-STD-020, Table 4-1, 4-2 and 5-2, Figure 5-1
Solderability	10X Magnification	J-STD-002, 95% Coverage
Vibration (High Frequency)	20g peak, 10-2000 Hz, 12 times in each of three perpendicular directions (total 36)	MIL-STD-202, Method 204, Condition D
Mechanical Shock	50g, 11 ms, 1/2-sine, 18 shocks: 3 each direction, each of 3 axes	MIL-STD-202, Method 213, Condition A
Marking Resistance to Solvents	Isopropyl alcohol + mineral spirits at 25°C; terpene defluxer at 25°C; distilled water + proylene glycol monomethyl ether + monoethanolamine at 63°C to 70°C	MIL-STD-202, Method 215